INTERNATIONAL STANDARD



Third edition 2006-11-01

Identification cards — Integrated circuit cards —

Part 3:

Cards with contacts — Electrical interface and transmission protocols

iTeh STANDARD PREVIEW Cartes d'identification — Cartes à circuit intégré — (Strartie 3: Cartes à contacts) Interface électrique et protocoles de transmission

<u>ISO/IEC 7816-3:2006</u> https://standards.iteh.ai/catalog/standards/sist/375db46f-0e0c-4c90-986c-5ff3b1ec76f7/iso-iec-7816-3-2006



Reference number ISO/IEC 7816-3:2006(E)

PDF disclaimer

This PDF file may contain embedded typefaces. In accordance with Adobe's licensing policy, this file may be printed or viewed but shall not be edited unless the typefaces which are embedded are licensed to and installed on the computer performing the editing. In downloading this file, parties accept therein the responsibility of not infringing Adobe's licensing policy. The ISO Central Secretariat accepts no liability in this area.

Adobe is a trademark of Adobe Systems Incorporated.

Details of the software products used to create this PDF file can be found in the General Info relative to the file; the PDF-creation parameters were optimized for printing. Every care has been taken to ensure that the file is suitable for use by ISO member bodies. In the unlikely event that a problem relating to it is found, please inform the Central Secretariat at the address given below.

iTeh STANDARD PREVIEW (standards.iteh.ai)

ISO/IEC 7816-3:2006 https://standards.iteh.ai/catalog/standards/sist/375db46f-0e0c-4c90-986c-5ff3b1ec76f7/iso-iec-7816-3-2006

© ISO/IEC 2006

All rights reserved. Unless otherwise specified, no part of this publication may be reproduced or utilized in any form or by any means, electronic or mechanical, including photocopying and microfilm, without permission in writing from either ISO at the address below or ISO's member body in the country of the requester.

ISO copyright office Case postale 56 • CH-1211 Geneva 20 Tel. + 41 22 749 01 11 Fax + 41 22 749 09 47 E-mail copyright@iso.org Web www.iso.org Published in Switzerland

Contents

Forewo	ord	iv		
Introductionv				
1	Scope	. 1		
2	Normative references	. 1		
3	Terms and definitions	. 1		
4	Symbols and abbreviated terms	. 3		
5 5.1 5.2	Electrical characteristics General Contacts	. 5 . 5 . 6		
6 6.1 6.2 6.3 6.4	Card operating procedure Principles Activation, resets and class selection Information exchange Deactivation	. 9 . 9 . 9 11 12		
7 7.1 7.2 7.3	Asynchronousicharacter I.A.NDARD PREVIEW Elementary time unit	13 13 13 14		
8 8.1 8.2 8.3	Answer to reset <u>ISO/IEC 7816-3:2006</u> Characters and coding ¹ conventions tandards/sist/375db46f-0e0c-4c90-986c- Answer-to-Reset <u>5ff3b1ec76f7/iso-iec-7816-3-2006</u> Global interface bytes	15 15 16 18		
9 9.1 9.2 9.3	Protocol and parameters selection PPS exchange PPS request and response Successful PPS exchange	20 20 20 21		
10 10.1 10.2 10.3	Protocol T=0, half-duplex transmission of characters Scope Character level Structure and processing of commands	22 22 22 22		
11 11.1 11.2 11.3 11.4 11.5 11.6	Protocol T=1, half-duplex transmission of blocks Scope and principles Character frame Block frame Protocol parameters Character component operation at data link layer Block component operation at data link layer	24 24 24 27 28 28		
12 12.1 12.2 12.3	Transmission of command-response pairs Application protocol data units Command-response pair transmission by T=0 Command-response pair transmission by T=1	32 32 34 40		
Annex A (informative) Scenarios for T=1				
Bibliog	raphy	50		

Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and non-governmental, in liaison with ISO and IEC, also take part in the work. In the field of information technology, ISO and IEC have established a joint technical committee, ISO/IEC JTC 1.

International Standards are drafted in accordance with the rules given in the ISO/IEC Directives, Part 2.

The main task of the joint technical committee is to prepare International Standards. Draft International Standards adopted by the joint technical committee are circulated to national bodies for voting. Publication as an International Standard requires approval by at least 75 % of the national bodies casting a vote.

ISO/IEC 7816-3 was prepared by Joint Technical Committee ISO/IEC JTC 1, *Information technology*, Subcommittee SC 17, *Cards and personal identification*.

This third edition cancels and replaces the second edition (ISO/IEC 7816-3:1997), which has been technically revised. It also incorporates the Amendment ISO/IEC 7816-3:1997/Amd.1:2002.

In addition, it incorporates material extracted from the first edition of Part 4 (ISO/IEC 7816-4:1995), so that the transmission protocols are no longer present in the second edition of Part 4 (ISO/IEC 7816-4:2005).

ISO/IEC 7816 consists of the following parts, under the general title Identification cards — Integrated circuit cards: https://standards.iteh.ai/catalog/standards/sist/375db46f-0e0c-4c90-986c-5ff3b1ec76f7/iso-iec-7816-3-2006

- Part 1: Cards with contacts Physical characteristics
- Part 2: Cards with contacts Dimensions and location of the contacts
- Part 3: Cards with contacts Electrical interface and transmission protocols
- Part 4: Organization, security and commands for interchange
- Part 5: Registration of application providers
- Part 6: Interindustry data elements for interchange
- Part 7: Interindustry commands for Structured Card Query Language (SCQL)
- Part 8: Commands for security operations
- Part 9: Commands for card management
- Part 10: Cards with contacts Electronic signals and answer to reset for synchronous cards
- Part 11: Personal verification through biometric methods
- Part 12: Cards with contacts USB electrical interface and operating procedures
- Part 13: Commands for application management in multi-application environment
- Part 15: Cryptographic information application

Introduction

ISO/IEC 7816 is a series of standards specifying integrated circuit cards and the use of such cards for interchange. These cards are identification cards intended for information exchange negotiated between the outside world and the integrated circuit in the card. As a result of an information exchange, the card delivers information (computation result, stored data), and/or modifies its content (data storage, event memorization).

Five parts are specific to cards with galvanic contacts and three of them specify electrical interfaces.

- ISO/IEC 7816-1 specifies physical characteristics for cards with contacts.
- ISO/IEC 7816-2 specifies dimensions and location of the contacts.
- ISO/IEC 7816-3 specifies electrical interface and transmission protocols for asynchronous cards.

NOTE The first and second editions of ISO/IEC 7816-3 specified an optional use of contact C6 to provide the card with programming power required to write or to erase internal non-volatile memory. As every card manufactured since 1990 internally generates programming power, this third edition deprecates this use, as well as the related indications in the Answer-to-Reset and the related controls in each transmission protocol.

- ISO/IEC 7816-10 specifies electrical interface and answer to reset for synchronous cards.
- ISO/IEC 7816-12 specifies electrical interface and operating procedures for USB cards.

All the other parts are independent of the physical interface technology. They apply to cards accessed by one or more of the following methods: contacts, close coupling and radio frequency.

- ISO/IEC 7816-4 specifies organization, security and commands for interchange.
- ISO/IEC 7816-5 specifies registration of application providers.
- ISO/IEC 7816-6 specifies interindustry data elements for interchange.
- ISO/IEC 7816-7 specifies commands for structured card query language.
- ISO/IEC 7816-8 specifies commands for security operations.
- ISO/IEC 7816-9 specifies commands for card management.
- ISO/IEC 7816-11 specifies personal verification through biometric methods.
- ISO/IEC 7816-13 specifies commands for application management in multi-application environment.
- ISO/IEC 7816-15 specifies cryptographic information application.

ISO/IEC 10536^[3] specifies access by close coupling. ISO/IEC 14443^[5] and ISO/IEC 15693^[6] specify access by radio frequency. Such cards are also known as contactless cards.

ISO and IEC draw attention to the fact that it is claimed that compliance with this document may involve the use of patents.

ISO and IEC take no position concerning the evidence, validity and scope of these patent rights.

The holders of these patent rights have assured ISO and IEC that they are willing to negotiate licences under reasonable and non-discriminatory terms and conditions with applicants throughout the world. In this respect, the statements of the holders of these patent rights are registered with ISO and IEC. Information may be obtained from the following companies.

Patent holder	Patent number	Details	Foreign equivalents
Toshiba Corporation	JPN 2537199	<i>Integrated circuit card,</i> (priority date: 1986-06-20; publication date: 1996-07-08)	FRA 8708646, FRA 8717770, USA 4833595, USA 4901276
Intellectual Property Division 1-1, Shibaura 1-Chome Minato-ku, Tokyo 105-8001, Japan	USA 5161231	Processing system which transmits a predetermined error code upon detection of an incorrect transmission code, (priority date: 1991-03-12; publication date: 1992-11-03)	FRA 8713306, FRA 9209880

iTeh STANDARD PREVIEW

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights other than those identified above. ISO and IEC shall not be held responsible for identifying any or all such patent rights.

<u>ISO/IEC 7816-3:2006</u> https://standards.iteh.ai/catalog/standards/sist/375db46f-0e0c-4c90-986c-5ff3b1ec76f7/iso-iec-7816-3-2006

Identification cards — Integrated circuit cards —

Part 3: Cards with contacts — Electrical interface and transmission protocols

1 Scope

This part of ISO/IEC 7816 specifies the power and signal structures, and information exchange between an integrated circuit card and an interface device such as a terminal.

It also covers signal rates, voltage levels, current values, parity convention, operating procedure, transmission mechanisms and communication with the card.

It does not cover information and instruction content, such as identification of issuers and users, services and limits, security features, journaling and instruction definitions REVIEW

Normative references (standards.iteh.ai)

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO/IEC 7816-2, Identification cards — Integrated circuit cards — Part 2: Cards with contacts — Dimensions and location of the contacts

ISO/IEC 7816-4, Identification cards — Integrated circuit cards — Part 4: Organization, security and commands for interchange

3 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

3.1

2

block

byte string comprising two or three fields defined as prologue field, information field and epilogue field

3.2

class of operating conditions

set of values for voltage and current

3.3

cold reset first reset occurring after activation

3.4

destination node address

portion of the node address byte, identifying the intended receiver of the block

3.5

elementary time unit

nominal duration of a moment within an asynchronous character

3.6

epilogue field

final field of a block, conveying the error detection code

3.7

identification card

card identifying its holder and issuer, which may carry data required as input for the intended use of the card and for transactions based thereon

[ISO/IEC 7810^[2]]

3.8

information block

block whose primary purpose is to convey application layer information

3.9

information field

field of a block, conveying data, generally application data

3.10

interface device

terminal, communication device or machine to which the card is electrically connected during operation

3.11 length byte

(standards.iteh.ai)

portion of the prologue field, encoding the number of bytes in the information field of the block

3.12

https://standards.iteh.ai/catalog/standards/sist/375db46f-0e0c-4c90-986c-5ff3b1ec76f7/iso-iec-7816-3-2006

node address byte

portion of the prologue field, indicating both destination and source addresses of the block

3.13

operating card

card that can correctly carry out all its functions

3.14

procedure byte

byte transmitted by the card for indicating the progression of a T=0 command and controlling the exchange of data bytes

3.15

prologue field

first field of a block, consisting of three bytes defined as node address, protocol control and length

3.16

protocol control byte

portion of the prologue field, encoding transmission control information

3.17

receive ready block

block conveying the send-sequence number of the expected I-block, used as a positive or negative acknowledgment

3.18

redundancy code

content of the epilogue field, computed from all the bytes in the prologue field and in the information field

3.19

source node address

portion of the node address byte, identifying the transmitter of the block

3.20

supervisory block

block conveying transmission control information

3.21

transmission control

function used to control the data transmission between the interface device and the card, including block transmission with sequence control, synchronization and recovery of transmission errors

3.22

warm reset

any reset that is not a cold reset

4 Symbols and abbreviated terms

For the purposes of this document, the following symbols and abbreviated terms apply.

A, B, C	classes of operating conditions
APDU	application protocol data unit
BGT	block guard timeh STANDARD PREVIEW
BWI	block waiting time integet and ards.iteh.ai)
BWT	block waiting time
CGT	ISO/IEC 7816-3:2006 character guard time systandards.iteh.ai/catalog/standards/sist/375db46f-0e0c-4c90-986c-
C_{IN}	input capacitance 5ff3b1ec76f7/iso-iec-7816-3-2006
CLA	class byte
CLK	clock contact
C_{OUT}	output capacitance
CRC	cyclic redundancy code
CWI	character waiting time integer
CWT	character waiting time
(C(6) C(7))	value of the concatenation of bytes $C(6)$ and $C(7)$ (the first byte is the most significant byte)
D	baud rate adjustment integer
DAD	destination node address
Dd, Di, Dn	default values, indicated values and negotiated values of D
etu	elementary time unit
F	clock rate conversion integer
f	frequency value of the clock signal provided to the card by the interface device
Fd, Fi, Fn	default values, indicated values and negotiated values of F
GND	ground contact
GT	guard time

ISO/IEC 7816-3:2006(E)

Н	high state
I-block	information block
I _{CC}	current at VCC
IFS	maximum information field size
IFSC	IFS for the card
IFSD	IFS for the interface device
I _{IH}	high level input current
I _{IL}	low level input current
INF	information field
INS	instruction byte
I _{OH}	high level output current
I _{OL}	low level output current
I/O	input/output contact
L	low state
L_{c} field	length field for coding number $N_{\rm c}$
L_{e} field	
LEN	length byte (standards.iteh.ai)
LRC	longitudinal redundancy code
Ν	extra guard time, integer, dards.iteh.ai/catalog/standards/sist/375db46f-0e0c-4c90-986c-
NAD	node address byte 5ff3b1ec76f7/iso-iec-7816-3-2006
Na	exact number of available data bytes
N_{c}	number of bytes in the command data field
Ne	maximum number of bytes expected in the response data field
N_{m}	number of remaining data bytes
Nr	number of bytes in the response data field
N_{x}	number of extra data bytes still available
OSI	open systems interconnection
PCB	protocol control byte
PPS	protocol and parameters selection
P1 P2	parameter bytes
R-block	receive ready block
RFU	reserved for future use
RST	reset contact
SAD	source node address
S-block	supervisory block
SPU	standard or proprietary use contact

state H	high electrical level
state L	low electrical level
SW1 SW2	status bytes
т	type
T=0	half duplex transmission of characters
T=1	half duplex transmission of blocks
ТА, ТВ,	interface bytes
тск	check character
<i>t</i> _F	fall time, from 90 % to 10 % of signal amplitude
TPDU	transmission protocol data unit
t _R	rise time, from 10 % to 90 % of signal amplitude
TS	initial character
то	format byte
T ₁ , T ₂ ,	historical bytes
$U_{\sf CC}$	voltage at VCC
U_{IH}	
U_{IL}	low level input voltage standards.iteh.ai)
U_{OH}	high level output voltage
U_{OL}	low level output voltage hai/catalog/standards/sist/375db46f-0e0c-4c90-986c-
NOTE In a V_{OH} and V_{OL} .	accordance with ISO 31 ^[1] , the symbols $U_{CC}^{-ie}U_{IH}^{-ie}U_{IL}^{-3}U_{OH}^{000}$ and U_{OL} replace the former symbols V_{CC} , V_{IH} , V_{IL} ,
VCC	supply power contact
WI	waiting time integer
WT	waiting time
WTX	waiting time extension
Х	clock stop indicator

- Y class indicator
- 'XY' notation using the hexadecimal digits '0' to '9' and 'A' to 'F', equal to XY to the base 16

5 Electrical characteristics

5.1 General

5.1.1 Contact assignment

The dimensions and location of the contacts shall be as specified in ISO/IEC 7816-2.

This part of ISO/IEC 7816 supports at least the following contacts.

- C1: supply power input (VCC, see 5.2.1).
- C2: reset signal input (RST, see 5.2.2).
- C3: clock signal input (CLK, see 5.2.3).
- C5: ground (GND, reference voltage).
- C6: standard or proprietary use (SPU, see 5.2.4).
- C7: input/output for serial data (I/O, see 5.2.5).

NOTE This document deprecates the use of contact C6 to provide the card with programming power because every card manufactured since 1990 internally generates programming power.

5.1.2 Measurement conventions

By definition, when a card and an interface device are mechanically connected, each contact of the card and the corresponding contact of the interface device together form an "electrical circuit".

All measurements on an electrical circuit are defined with respect to GND and in an ambient temperature range 0° C to 50° C. All currents flowing into the card are considered positive. All timings shall be measured with respect to the appropriate threshold levels.

By definition, an electrical circuit is "not active" when the voltage with respect to GND remains between 0 V and 0,4 V for currents less than 1 mA flowing into the interface device.

5.1.3 Classes of operating conditions

ISO/IEC 7816-3:2006

This document defines three classes of operating conditions, based on the nominal supply voltage provided to the card by the interface device through VCC.fl3blec76f7/iso-iec-7816-3-2006

- 5 V for class A.
- 3 V for class B.
- 1,8 V for class C.

The card shall support one or more classes. If the interface device applies a class supported by the card, then the card shall operate as specified.

- If the card supports more than one class, those classes shall be consecutive.
- If the interface device offers more than one class, the order in which those classes are applied is not within the scope of this document.

No card shall be damaged when the interface device applies a class not supported by the card (by definition, a damaged card no longer operates as specified or contains corrupt data).

5.2 Contacts

5.2.1 VCC (C1)

This contact is used to supply the card with power.

Symbol	Conditions	Minimum	Maximum	Unit
	Class A	4,5	5,5	
U_{CC}	Class B	2,7	3,3	V
	Class C	1,62	1,98	
	Class A, at maximum allowed frequency		60	
I _{CC}	Class B, at maximum allowed frequency		50	mA
	Class C, at maximum allowed frequency		30	
	When the clock is stopped, see 6.3.2		0,5	
The current value	e is averaged over 1 ms	-1		1

Table 1 — Electrical characteristics of VCC under normal operating conditions

The maximum current is defined for the card. The interface device shall be able to deliver this current within the range specified for the voltage value and may deliver more. The supply power shall maintain the voltage value within the specified range despite transient power consumption as defined in Table 2.

Class	Maximum charge ^a	Maximum duration	Maximum variation ^b of <i>I</i> _{CC}		
А	20 nA.s	400 ns	100 mA		
В	10 nA.s	400 ns	50 mA		
C 6 nA.s 400 ns 30 mA					
^a The maximum charge is half the product of the maximum duration and the maximum variation. ^b The maximum variation is the difference in supply current with respect to the average value.					

Table 2 — Spikes on Icc

standards.iteh.ai)

5.2.2 RST (C2)

ISO/IEC 7816-3:2006

This contact is used to provide the card with reset signal. See 6.2.2 (cold reset) and 6.2.3 (warm reset).

Table 3 — Electrical characteristics of RST under	normal operating conditions
---------------------------------------------------	-----------------------------

Symbol	Conditions	Minimum	Maximum	Unit	
UIH		0,8 Ucc	Ucc	V	
I_{IH}	U_{IH}	-20	+150	μA	
U_{IL}		0	0,12 U _{CC}	V	
I_{IL}	U_{IL}	-200	+20	μA	
t _R t _F	C _{IN} = 30 pF		1	μs	
The voltage shall remain between – 0,3 V and U_{CC} + 0,3 V.					

5.2.3 **CLK (C3)**

This contact is used to provide the card with clock signal. The actual value of the frequency of the clock signal is denoted f. The minimum value shall be 1 MHz. At least during activation (see 6.2.1) and cold reset (see 6.2.2), the maximum value shall be 5 MHz. For the maximum value supported by the card, see Table 7.

Unless otherwise specified, the duty cycle of the clock signal shall be between 40 % and 60 % of the cycle during stable operation. When switching the frequency from one value to another, care should be taken to ensure that no pulse is shorter than 40 % of the shortest cycle allowed by the card (see maximum frequency in Table 7). No information shall be exchanged when switching the frequency value. Two different times are recommended for switching the frequency value, either

- after completion of an answer to reset, see 8.1, while the card is waiting for a character, or
- after completion of a successful PPS exchange, see 9.3, while the card is waiting for a character.

Symbol	Conditions	Minimum	Maximum	Unit
UIH		0,7 Ucc	Ucc	V
I _{IH}	U_{IH}	-20	+100	μA
UIL	Class A and class B	0	0,5	V
U_{IL}	Class C	0	0,2 Ucc	V
I _{IL}	U_{IL}	-100	+20	μA
t _R t _F	<i>С</i> _{IN} = 30 рF		9 % of cycle	
The voltage shall ren	nain between – 0,3 V and U_{CC} + 0,3 V.			

Table 4 — Electrical characteristics of CLK under normal operating conditions

5.2.4 SPU (C6)

This contact is available for either standard or proprietary use, as input and/or output.

Depending upon whether the card uses SPU or not, the first TB for T=15 shall be present or absent in the Answer-to-Reset: this global interface byte (see 8.3) indicates whether the use is standard or proprietary. ISO/IEC JTC 1/SC 17 reserves the standard use for future use.

When the card is powered through VCC, if contact C6 is connected in the interface device, then the voltage shall remain between – 0,3 V and U_{CC} + 0,3 V.

No card shall be damaged by an interface device where contact C6 is connected to VCC or GND as such an interface device complies with the previous edition (ISO/IEC 7816-3:1997).

5.2.5 I/O (C7)

iTeh STANDARD PREVIEW (standards iteh ai)

This contact is used as input (reception mode) or output (transmission mode). The information exchange uses two states of the electrical circuit as follows:

- state H if the card and the interface device are in reception model of if the transmitter imposes this state;

5ff3b1ec76f7/iso-iec-7816-3-2006

state L if the transmitter imposes this state.

When both the card and the interface device are in reception mode, the electrical circuit shall be at state H. When the card and the interface device are in non-matched transmission mode, the state may be indeterminate. During operation, the interface device and the card shall not be simultaneously in transmission mode.

The interface device shall be able to support the defined range of input currents when the input voltages are within the allowed range. The impedance presented by the interface device to the card shall allow the card to keep the output voltages within the defined range.

Table 5 — Electrical characteristics of I/O under normal or	perating conditions
-------------------------------------------------------------	---------------------

Symbol	Conditions	Minimum	Maximum	Unit
UIH		0,7 Ucc	Ucc	V
I_{IH}	U_{IH}	-300	+20	μA
U_{IL}		0	0,15 Ucc	V
I_{IL}	U_{IL}	-1000	+20	μA
U_{OH}	External pull-up resistor: 20 k Ω to U_{CC}	0,7 U _{CC}	$U_{\sf CC}$	V
I _{OH}	U_{OH} and external pull-up resistor: 20 k Ω to U_{CC}		+20	μA
U_{OL}	I_{OL} = 1 mA for class A ^a and class B ^a	0	0,15 Ucc	V
	I_{OL} = 500 µA for class C ^a			
t _R t _F	C _{IN} = 30 рF; C _{OUT} = 30 рF		1	μs
The voltage shall remain between – 0,3 V and U_{CC} + 0,3 V.				
^a Interface device implementations should not require the card to sink more than 500 μA.				

6 Card operating procedure

6.1 **Principles**

The electrical circuits shall remain not active until the contacts of the card are mechanically connected to the contacts of the interface device. The interaction between the interface device and the card shall be conducted through the following sequence of operations.

- The interface device shall apply a class of operating conditions to the electrical circuits, i.e., activation, cold reset and possibly one or more warm resets. If the card supports the class, it shall answer to reset according to clause 8. The interface device ends up with a complete and valid Answer-to-Reset and a class of operating conditions. The interface device shall be able to repeat the entire operation.
- For exchanging information, the card and the interface device shall agree on a transmission protocol and values of transmission parameters. Clause 10 specifies T=0, the half-duplex transmission of characters with the interface device as the master. Clause 11 specifies T=1, the half-duplex transmission of blocks. Clause 12 specifies the transmission of command-response pairs by T=0 and by T=1. When no transmission is expected from the card (e.g., after processing a command-response pair and before initiating the next one), the interface device may stop the clock signal if the card supports clock stop.
- The interface device shall perform a deactivation.

The deactivation should be completed before the mechanical disconnection between the contacts of the card and the contacts of the interface device.

6.2 Activation, resets and class selection iTeh STANDARD PREVIEW

621 Activation

(standards.iteh.ai) In order to initiate an interaction with a mechanically connected card, the interface device shall activate the electrical circuits according to a class of operating conditions: A, B or C, see 5.1.3, in the following order.

- RST shall be putito state dar see 5a2c2talog/standards/sist/375db46f-0e0c-4c90-986c-
- Sff3b1ec76f7/iso-iec-7816-3-2006
 VCC shall be powered, see 5.2.1.
- I/O in the interface device shall be put in reception mode, see 5.2.5. The interface device shall ignore the state on I/O during activation.
- CLK shall be provided with a clock signal, see 5.2.3.

NOTE 1 The delays between powering VCC, setting I/O in reception mode and providing the clock signal on CLK are not defined.

NOTE 2 The interface device may perform a deactivation due to short circuits.

Figure 1 summarizes activation (before time T_a) and cold reset (after time T_a).



